# TOIREX

# **XP162A12A6PR**

ETR1126\_001

#### Power MOSFET

#### ■ GENERAL DESCRIPTION

The XP162A12A6PR is a P-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

A gate protect diode is built-in to prevent static damage.

The small SOT-89 package makes high density mounting possible.

#### **■**APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

### **■**FEATURES

**Low On-State Resistance** : Rds(on) =  $0.17 \Omega$  @ Vgs = -4.5V

: Rds(on) =  $0.3 \Omega$  @ Vgs = -2.5V

Ultra High-Speed Switching

Dribing Voltage : -2.5V

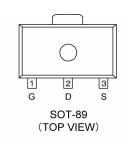
Gate Protect Diode Built-in

P-Channel Power MOSFET

**DMOS Structure** 

Small Package : SOT-89

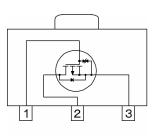
#### ■PIN CONFIGURATION



#### ■ PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1	G	Gate
2	D	Drain
3	S	Source

#### **■**EQUIVALENT CIRCUIT



P-channel MOSFET (1 device built-in)

#### ■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	Vdss	-20	V
Gate-Source Voltage	Vgss	±12	V
Drain Current (DC)	ld	-2.5	Α
Drain Current (Pulse)	ldp	-10	Α
Reverse Drain Current	ldr	-2.5	Α
Channel Power Dissipation *	Pd	2	W
Channel Temperature	Tch	150	°C
Storage Temperature Ramge	Tstg	-55~150	လ

<sup>\*</sup> When implemented on a ceramic PCB

# **■**ELECTRICAL CHARACTERISTICS

DC Characteristics Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds= -20V, Vgs= 0V	-	-	-10	μΑ
Gate-Source Leak Current	Igss	Vgs= ±12V, Vds= 0V	-	-	±10	μΑ
Gate-Source Cut-Off Voltage	Vgs(off)	Id= -1mA, Vds= -10V	-0.5	-	-1.2	V
Drain-Source On-State Resistance*1	Rds(on)	Id= -1.5A, Vgs= -4.5V	-	0.13	0.17	Ω
		Id= -1.5A, Vgs= -2.5V	-	0.22	0.30	Ω
Forward Transfer Admittance*1	Yfs	Id= -1.5A, Vds= -10V	-	4	-	S
Body Drain Diode Forward Voltage	Vf	If= -2.5A, Vgs= 0V	-	-0.85	-1.1	V

<sup>\*1</sup> Effective during pulse test.

## **Dynamic Characteristics**

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= -10V, Vgs=0V f= 1MHz	-	310	-	pF
Output Capacitance	Coss		-	200	-	pF
Feedback Capacitance	Crss		-	90	-	pF

## **Switching Characteristics**

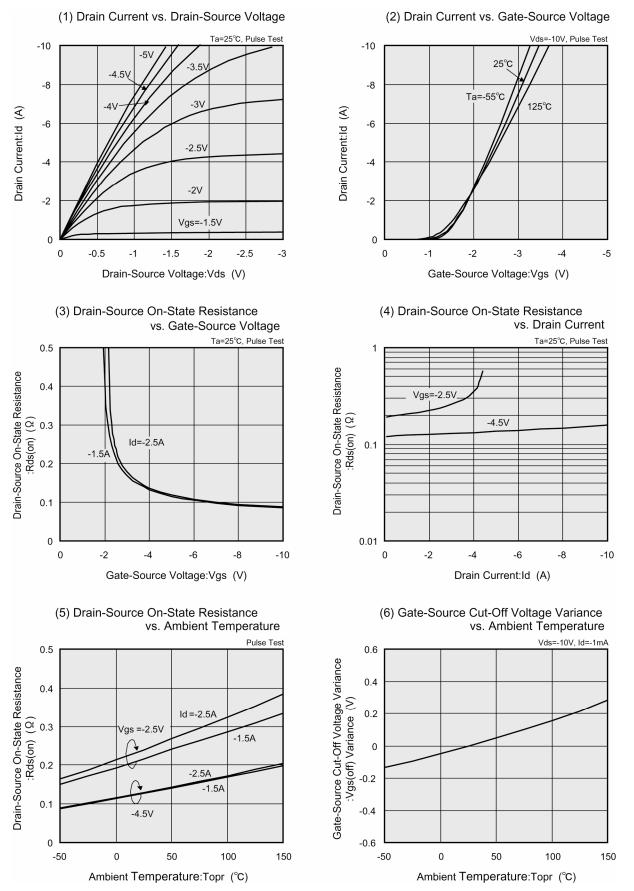
Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= -5V, Id= -1.5A Vdd= -10V	-	5	-	ns
Rise Time	tr		-	15	-	ns
Turn-Off Delay Time	td (off)		-	55	-	ns
Fall Time	tf		-	55	-	ns

#### **Thermal Characteristics**

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	62.5	-	°C/W

## **■TYPICAL PERFORMANCE CHARACTERISTICS**



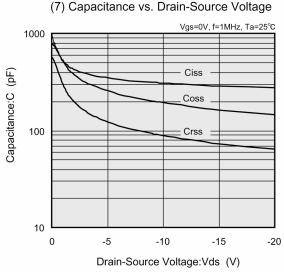
# ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

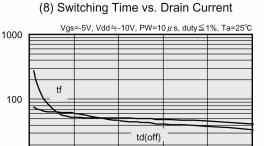
Switching Time:t (ns)

10

0

-1



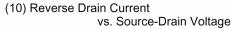


td(on)

-3

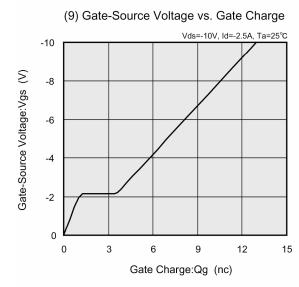
-5

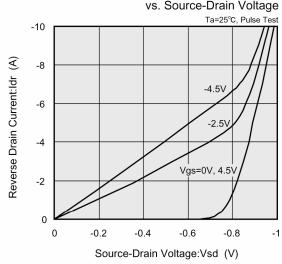




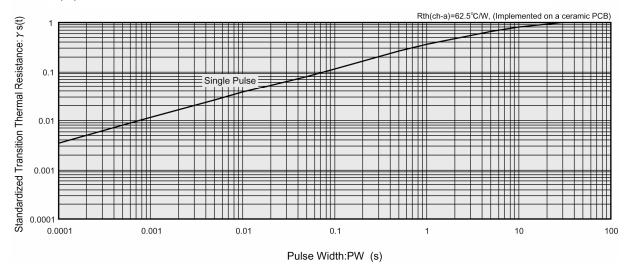
Drain Current:Id (A)

-2









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